

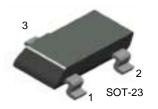
FYV0704S

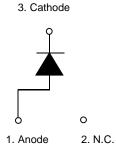
Features

- Very low forward voltage drop
- High frequency properties and switching speed
- Guard ring for over-voltage protection

Applications

- DC-DC converters
- Freewheeling diodes





marking



SCHOTTKY BARRIER RECTIFIER

Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{RRM}	Maximum Repetitive Reverse Voltage	40	V
V _R	Maximum DC Reverse Voltage	40	V
I _{F(AV)}	Average Rectified Forward Current @ T _A = 40°C	0.75	Α
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	8	А
TJ	Operating Junction Temperature	-65 to +125	°C
T _{STG}	Storage Temperature	-65 to +150	°C

Thermal Characteristics

Symbol		Parameter	Value	Units
	$R_{\theta,JA}$	Thermal Resistance, Junction to Ambient	250	°C/W

Electrical Characteristics

Symbol	Parameter		Min.	Тур.	Max.	Units
V _F *	Forward Voltage Drop					V
	$I_F = 50 \text{mA}$	T _A = 25 °C	-	0.270	-	
	I _F = 100mA	T _A = 25 °C	-	0.290	-	
	I _F = 500mA	T _A = 25 °C	-	0.380	-	
	I _F = 750mA	T _A = 25 °C	-	0.425	0.48	
	I _F = 1A	T _A = 25 °C	-	0.460	-	
	I _F = 1.5A	T _A = 25 °C	-	0.535	-	
	I _F = 750mA	T _A = 125 °C	-	0.375	-	
I _R *	Reverse Current					mA
**	@ rated V _R	T _A = 25 °C	-	0.02	0.1	
		T _A = 125 °C	-	10	-	

^{*} Pulse Test: Pulse Width=300μs, Duty Cycle=2%

Typical Characteristics

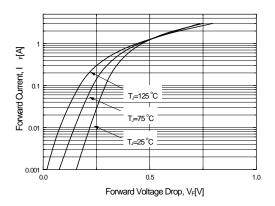


Figure 1. Typical Forward Voltage Characteristics

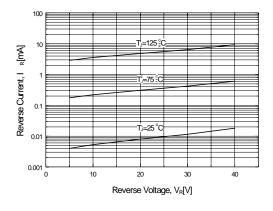


Figure 2. Typical Reverse Current vs. Reverse Voltage

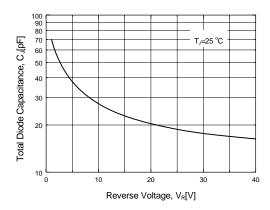


Figure 3. Total Diode Capacitance

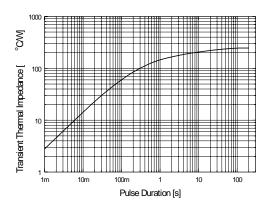


Figure 4. Thermal Impedance Characteristics

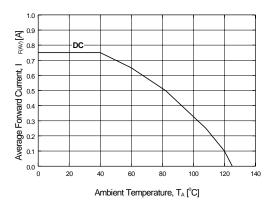


Figure 5. Forward Current Derating Curve

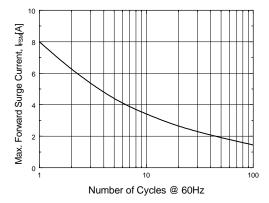
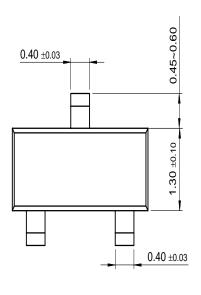


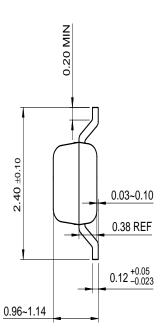
Figure 6. Non-Repetive Surge Current

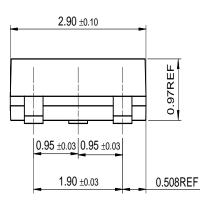
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Package Dimensions

SOT-23







Dimensions in Millimeters

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CROSSVOLT™	GlobalOptoisolator™	PowerTrench [®]	SyncFET™
DenseTrench™	GTO™	QFET™	TinyLogic™
DOME™	HiSeC™	QS™	UHC™
EcoSPARK™	ISOPLANAR™	QT Optoelectronics™	UltraFET [®]
E ² CMOS [™]	LittleFET™	Quiet Series™	VCX™
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Rev. H2

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Datasheet Identification	Product Status	Definition
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